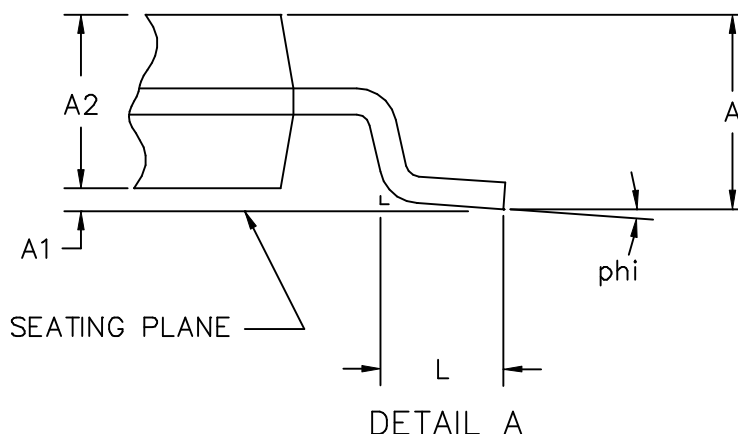



THIS TABLE IN INCHES

SYM	MIN	MAX
A	.094	.104
A1	.004	---
A2	.090	.094
c	.009	.0125
phi	0°	8°
L	.016	.040
e1	.050 BSC	
B	.014	.020
n	28	
D	.698	.711
E	.291	.299
H	.398	.416



NOTES:

1. DIMENSIONS 'D' AND 'E' ARE MEASURED AT MOLD PARTING LINE AND DO NOT INCLUDE MOLD FLASH.
2. CONTROLLING DIMENSIONS: INCHES.

SIGNATURE		DATE		 Dallas Semiconductor			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:				TITLE MARKETING OUTLINE, 28-LD SOIC, .300 INCH			
		SIZE A	FSCM NO	PART NO.		REV B	
DO NOT SCALE DWG.		SCALE N/A		SHEET 1 OF 1			